Contact Name  Title - Contact  Product-Env-Stewards  Product Enviro Compliance  Authorized Representative*  Title - Representative  Phone - Contact*  Email - Contact*  Product-Env-Stewards@onsemi.com Product-Env-Stewards@onsemi.com Phone - Representative*  Email - Representative*	© Copy	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
Company name* Company unique ID  Unique ID Authority  Description										als and Mf	g Informat	tion			
Insemi  Insemi	Cormation	1													
Title - Contact   Phone - Contact*   Phone - Contact*   Product-Env-Stewards   Product-Env-	Company name*			Company un	Company unique ID			Unique ID Authority				Response Date*			
Product-Env-Stewards Product Enviro Compliance Product-Env-Stewards Prod												2025-08-2	24		
Authorized Representative*  Title - Representative  Product Enviro Compliance  Requester Item Number  Mfr Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  NCP551SN50T1G  ANA 5.0V LOW DROP OUT REG  2025-08-24  MY1  14.08  mg  Manufacturing Process Information  Terminal Plating / Grid Array Material  Terminal Base Alloy  Matte Tin (Sn) - annealed  CU Alloy  1  Phone - Representative*  Requester Item Number  NA  Product-Env-Stewards@onsemi.com  Manufacturing Site  Weight*  UOM  MY1  14.08  mg  Peak Process Body Temperature  Max Time at Peak Temperature  Number of Reflow Cycle  Matte Tin (Sn) - annealed  CU Alloy  1  260  C  30  Seconds  3			,	Title - Conta	ct		]	Phone - Contac	t*			Email - C	ontact*		
Product-Env-Stewards Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM NCP551SN50T1G ANA 5.0V LOW DROP OUT REG  2025-08-24 MY1 14.08 mg  Manufacturing Process Information  Terminal Plating / Grid Array Material Terminal Base Alloy Terminal Plating / Grid Array Material Terminal Plating / Grid Array Material Terminal Research Terminal Researc	Product-Env-Stewards Pr				Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Authorized Representative* Title - Repres				presentative			Phone - Representative*			Email - Representative*				
NCP551SN50T1G   ANA 5.0V LOW DROP OUT REG   2025-08-24   MY1   14.08   mg	Product-Env-Stewards Product 1			Product Envi	roduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Manufacturing Proccess Information         Terminal Plating / Grid Array Material       Terminal Base Alloy       J-STD-020 MSL Rating       Peak Process Body Temperature       Max Time at Peak Temperature       Number of Reflow Cycle         Matte Tin (Sn) - annealed       CU Alloy       1       260       C       30       seconds       3	Requester Item Number		Mfr Item Number		Mfr Item Name			Effective Date	Version Manufacturing Site		W	eight*	UOM	Unit Type	
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycle Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3			NCP551SN	N50T1G	ANA 5.0V LOW I	DROP OUT R	EG	2025-08-24		М	Y1	14	1.08	mg	Each
Matte Tin (Sn) - annealed CU Alloy 1 260 C 30 seconds 3				rminal Rass	Alloy	STD 020 MS	I Pating	Dank Dean	see Rody To	nnarature	May Time at Pook	Tamparatu	ra Numi	har of Paflaw Cya	loc
		•			Alloy J-	31D-020 M3	ol Kaung			•				bei of Kellow Cyc	108
omments	te тш (эп) - ап	- anneateu	CC	Alloy	1			200		<u> </u>	30	second	5   3		
red 1 marinum time at neels termonature during coldering is 10.20 seconds	time at	neals temperature	lumina as l-l	louina ia 10-1	20 soconds										
vel 1 - maximum time at peak temperature during soldering is 10-30 seconds or more information regarding material composition please refer to page 3		• • • • • • • • • • • • • • • • • • • •													

RoHS Material Composition Declaration			Declaration Type *	Detail	led
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an		
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the company that the company tha	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit ide in you believe may apply. If the part is an assembly is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not e at least as comprehensive as the hts and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.42	mg	Supplier	Silicon (Si)	7440-21-3		0.42	mg
Die Attach	0.11	mg	Supplier	Silver (Ag)	7440-22-4		0.088	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.022	mg
Lead Frame	5.78	mg	Supplier	Silver (Ag)	7440-22-4		0.0705	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0069	mg
			Supplier	Iron (Fe)	7439-89-6		0.1358	mg
			Supplier	Copper (Cu)	7440-50-8		5.565	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0017	mg
Mold Compound-Black	7.34	mg		Epoxy resin	proprietary data		0.367	mg
			Supplier	Phenolic Resin	Proprietary Data		0.367	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.1468	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0367	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		6.4225	mg
Plating	0.39	mg	Supplier	Tin (Sn)	7440-31-5		0.39	mg
Wire Bond - Au	0.04	mg	Supplier	Gold (Au)	7440-57-5		0.04	mg